



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : **Confirmation No. 8286**
Masahiro ONO et al. : Docket No. 2002_0013A
Serial No. 10/030,739 : Group Art Unit 2814
Filed January 11, 2002 : Examiner Nathan W. Ha

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CIRCUIT SUBSTRATE FOR PACKAGING
SEMICONDUCTOR DEVICE, METHOD FOR
PRODUCING THE SAME, AND METHOD
FOR PRODUCING SEMICONDUCTOR DEVICE
PACKAGE STRUCTURE USING THE SAME

THE COMMISSIONER IS AUTHORIZED
TO CHARGE ANY DEFICIENCY IN THE
FEES FOR THIS PAPER TO DEPOSIT
ACCOUNT NO. 23-0975

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Responsive to the Office Action mailed October 3, 2004, the time for responding thereto being extended for one month in accordance with a Petition for Extension submitted herewith, please amend the above-identified application as follows: